IXYS CPC1303 Optocoupler Datasheet

http://www.manuallib.com/ixys/cpc1303-optocoupler-datasheet.html

Description

The CPC1303 is a unidirectional input optocoupler with a single-transistor output, which uses optically coupled technology to provide an enhanced 5000Vrms isolation barrier between the input and the output. The optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

ManualLib.com collects and classifies the global product instrunction manuals to help users access anytime and anywhere, helping users make better use of products.

http://www.manuallib.com





CPC1303 Optocoupler with Single-Transistor Output

Parameter	Rating	Units
Breakdown Voltage - BV _{CEO}	30	V_{P}
Current Transfer Ratio	200	%
Saturation Voltage	0.5	V
Input Control Current	0.2	mA

Features

- 5000V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 4-pin Package
- · Machine Insertable, Wave Solderable

Applications

- Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- · Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The CPC1303 is a unidirectional input optocoupler with a single-transistor output, which uses optically coupled technology to provide an enhanced $5000V_{rms}$ isolation barrier between the input and the output. The optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

This optocoupler satisfies the PD output requirements of IXYS Integrated Circuits Division's CPC1466 Broadband ADSL/VDSL DC Termination IC.

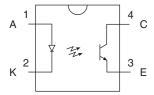
Approvals

- UL 1577 Approved Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN 60950 Certified Component: TUV Certificate B 10 05 49410 006

Ordering Information

Part Number	Description
CPC1303G	4-Pin DIP (100/Tube)
CPC1303GR	4-Pin Surface Mount (100/Tube)
CPC1303GRTR	4-Pin Surface Mount (1000/Reel)

Pin Configuration











Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Breakdown Voltage	30	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Power Dissipation ²		
Input ¹	150	mW
Phototransistor ²	150	
Isolation Voltage, Input to Output	5000	V _{rms}
Operating Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

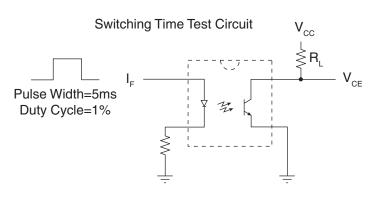
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

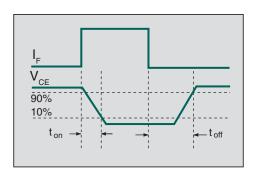
Electrical Characteristics @ 25°C

Parameters	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics	'				<u>'</u>	
Phototransistor Breakdown Voltage	I _{CEO} =10μA	BV _{CEO}	30	-	-	V _P
Phototransistor Output (Dark) Current	V _{CEO} =5V, I _F =0mA	V _{CEO} =5V, I _F =0mA I _{CEO}		25	500	nA
Saturation Voltage	I _C =0.4mA, I _F =0.2mA	V	-	0.1	0.45	V
	I _C =10mA, I _F =10mA	- V _{CEsat}	-	0.12	0.5	V
Current Transfer Ratio	I _F =0.2mA, V _{CE} =0.5V	CTR	200	1000	2500	%
Output Capacitance	V _{CEO} =25V, f=1MHz	C _{OUT}	-	6	-	pF
Input Characteristics	<u>.</u>			•		
Input Control Current	I _C =0.4mA, V _{CE} =0.5V	l _F	-	-	0.2	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Input Reverse Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics	•			•	•	
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

Switching Characteristics @ 25°C

Characteristic	Symbol	Test Condition	Тур	Units
Turn-On Time	t _{on}	$V_{CC} = 5V, I_{E} = 1 \text{mA}, R_{I} = 500\Omega$	2	116
Turn-Off Time	t _{off}	V _{CC} -5 v, I _F -1111A, II _L -50052	8	μ\$





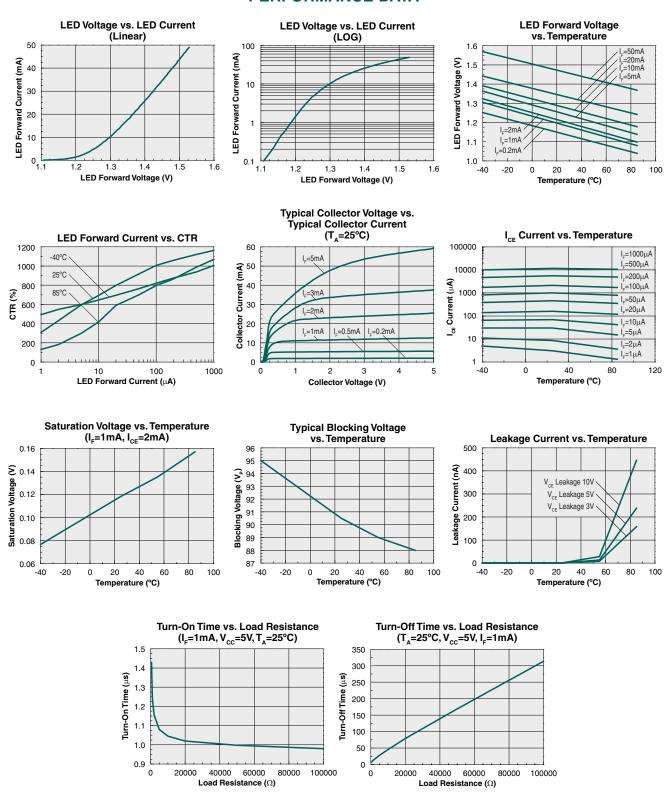
2 www.ixysic.com

¹ Derate linearly 1.33 mW / °C

² Derate linearly 2.00 mW / °C



PERFORMANCE DATA*



^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

R04 www.ixysic.com 3



Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1303G / CPC1303GR	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1303G / CPC1303GR	250°C for 30 seconds

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.







 2.540 ± 0.127

 (0.100 ± 0.005)

Dimensions

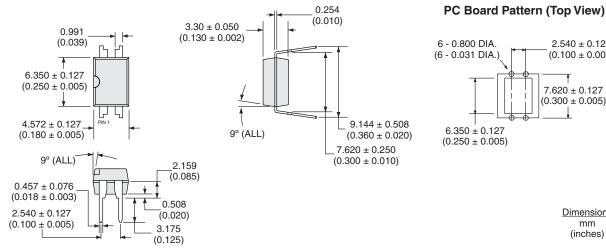
(inches)

 7.620 ± 0.127 (0.300 ± 0.005)

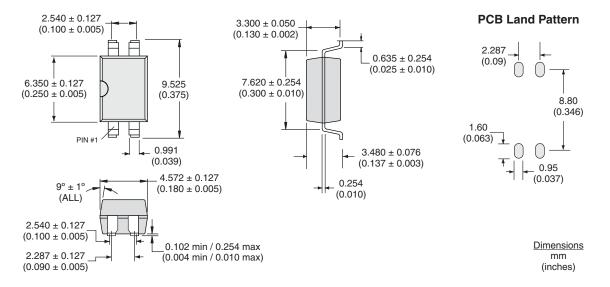


MECHANICAL DIMENSIONS

CPC1303G

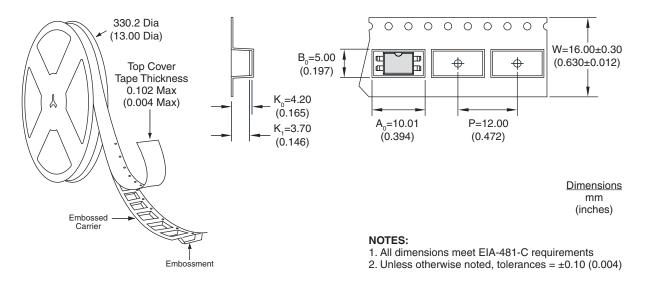


CPC1303GR





CPC1303GRTR Tape & Reel



For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.

Specification: DS-CPC1303-R04 @Copyright 2012, IXYS Integrated Circuits Division All rights reserved. Printed in USA. 12/16/2012